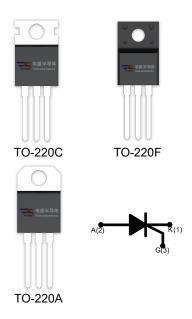


#### **DESCRIPTION:**

With high ability to withstand the shock loading of large current, TXN825 series of silicon controlled rectifiers provide high dv/dt rate with strong resistance to electromagnetic interference. They are especially recommended for use on solid state relay, motorcycle, power charger, T-tools etc.



### **MAIN FEATURES**

Symbol	JCT625	JCT825	
VDRM/ VRRM	600V	800V	
I <sub>T(RMS)</sub>	25A		
lgт	≤40mA		

## **ABSOLUTE MAXIMUM RATINGS**

Parameter		Symbol	Value	Unit
Storage junction temperature range		T <sub>stg</sub>	-40-150	$^{\circ}\!\mathbb{C}$
Operating junction temperature range		Tj	-40-150	$^{\circ}\!\mathbb{C}$
Repetitive peak off-state voltage(T <sub>j</sub> =25℃)		V <sub>DRM</sub>	600/800	V
Repetitive peak reverse voltage(T <sub>j</sub> =25℃)		V <sub>RRM</sub>	600/800	V
RMS on-state current	TO-220A(Ins)/ TO-220F(Ins) (Tc=95°C) TO-220A(Non-Ins)/ TO-220C(Tc=115°C)	I <sub>T(RMS)</sub>	25	A
Non repetitive surge peak on-state current (tp=10ms)		Ітѕм	300	Α
I <sup>2</sup> t value for fusing (tp=10ms)		l <sup>2</sup> t	450	A <sup>2</sup> s



Critical rate of rise of on-state current (I <sub>G</sub> =2×I <sub>GT</sub> )	dl/dt	50	A/µs
Peak gate current	I <sub>GM</sub>	4	Α
Average gate power dissipation	P <sub>G(AV)</sub>	1	W
Peak gate power	P <sub>GM</sub>	5	W

# **ELECTRICAL CHARACTERISTICS** ( $T_j$ =25 $^{\circ}$ C unless otherwise specified)

Symbol	Test Condition	Value			I I sa i 4
	rest Condition	MIN.	TYP.	MAX.	Unit
lgт	V -40V D -220	-	-	40	mA
V <sub>G</sub> T	V <sub>D</sub> =12V R <sub>L</sub> =33Ω	-	-	1.3	V
V <sub>GD</sub>	$V_D=V_{DRM}T_j=150^{\circ}C$ RL=3.3K $\Omega$	0.2	-	-	V
IL	I <sub>G</sub> =1.2I <sub>GT</sub>	-	-	90	mA
Ін	I <sub>T</sub> =500mA	-	-	80	mA
dV/dt	V <sub>D</sub> =2/3V <sub>DRM</sub> Gate Open T <sub>j</sub> =150℃	200	-	-	V/µs

# **STATIC CHARACTERISTICS**

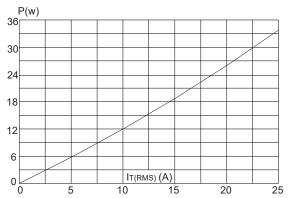
Symbol	Parameter		Value(MAX)	Unit
V <sub>TM</sub>	I <sub>TM</sub> =50A tp=380μs	T <sub>j</sub> =25℃	1.55	V
I <sub>DRM</sub>	VD=VDRM VR=VRRM	T <sub>j</sub> =25℃	10	μA
IRRM		Tj=150°C	4	mA

# **THERMAL RESISTANCES**

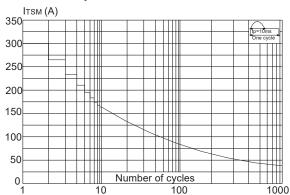
Symbol	Parameter		Value	Unit
R <sub>th(j-c)</sub>	junction to case(AC)	TO-220A(Ins)/ TO-220F(Ins)	1.7	℃/W
		TO-220A(Non-Ins)/ TO-220C	1.0	



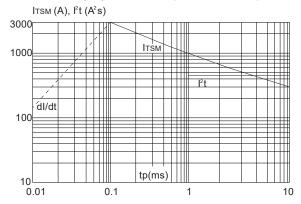
**FIG.1:** Maximum power dissipation versus RMS on-state current



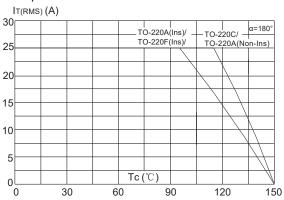
**FIG.3:** Surge peak on-state current versus number of cycles



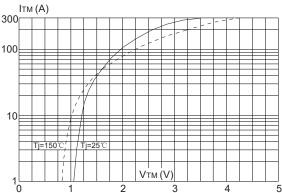
**FIG.5:** Non-repetitive surge peak on-state current for a sinusoidal pulse with width tp<10ms, and corresponging value of I²t (dI/dt < 50A/ μs)



**FIG.2:** RMS on-state current versus case temperature



**FIG.4:** On-state characteristics (maximum values)



**FIG.6:** Relative variations of gate trigger current, holding current and latching current versus junction temperature

